

Thyristor Module

MCC21-16io8B

V_{RRM}	<i>=</i> 2x 1600 V				
I _{tav}	=	21 A			
V _T	=	1.52 V			

Phase leg

Part number MCC21-16io8B



Backside: isolated



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Features / Advantages:

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability
- Direct Copper Bonded Al2O3-ceramic

Applications:

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control

Package: TO-240AA

- Isolation Voltage: 4800 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

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MCC21-16io8B

Thyristo				1	Ratings	>	1
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V _{RSM/DSM}	max. non-repetitive reverse/forwa	rd blocking voltage	$T_{VJ} = 25^{\circ}C$			1700	V
V _{RRM/DRM}	max. repetitive reverse/forward b		$T_{VJ} = 25^{\circ}C$			1600	V
R/D	reverse current, drain current	V _{R/D} = 1600 V	$T_{VJ} = 25^{\circ}C$			100	μA
		V _{R/D} = 1600 V	$T_{VJ} = 125^{\circ}C$			5	mA
V _T	forward voltage drop	$I_{T} = 45 \text{ A}$	$T_{VJ} = 25^{\circ}C$			1.45	V
		$I_{T} = 90 \text{ A}$				1.89	V
		$I_{T} = 45 \text{ A}$	$T_{VJ} = 125 \degree C$			1.52	V
		I _T = 90 A				2.20	V
I TAV	average forward current	$T_c = 85^{\circ}C$	$T_{VJ} = 125 ^{\circ}C$			21	A
T(RMS)	RMS forward current	180° sine				33	A
V _{to}	threshold voltage	oss calculation only	$T_{vJ} = 125^{\circ}C$			0.85	V
r _T	slope resistance f Tor power in	oss calculation only				15	mΩ
R _{thJC}	thermal resistance junction to cas	e				1.1	K/W
R _{thCH}	thermal resistance case to heatsi	nk			0.2		K/W
P _{tot}	total power dissipation		$T_c = 25^{\circ}C$			90	W
I _{TSM}	max. forward surge current	t = 10 ms; (50 Hz), sine	$T_{VJ} = 45^{\circ}C$			320	A
		t = 8,3 ms; (60 Hz), sine	$V_{R} = 0 V$			345	A
		t = 10 ms; (50 Hz), sine	T _{vJ} = 125°C			270	A
		t = 8,3 ms; (60 Hz), sine	$V_{R} = 0 V$			295	A
I ² t value for fusing	value for fusing	t = 10 ms; (50 Hz), sine	$T_{VJ} = 45^{\circ}C$			510	A ² s
		t = 8,3 ms; (60 Hz), sine	$V_{R} = 0 V$			495	A²s
		t = 10 ms; (50 Hz), sine	T _{VJ} = 125°C			365	A ² s
		t = 8,3 ms; (60 Hz), sine	$V_{R} = 0 V$			360	A²s
C	junction capacitance	$V_{\rm B} = 400 \text{V}$ f = 1 MHz	$T_{VJ} = 25^{\circ}C$		22		pF
P _{GM}	max. gate power dissipation	t _P = 30 μs	T _c = 125°C			10	W
		t _P = 300 μs				5	W
PGAV	average gate power dissipation					0.5	W
(di/dt) _{cr}	critical rate of rise of current	$T_{v,i} = 125 ^{\circ}C; f = 50 \text{Hz}$ re	epetitive, $I_{T} = 45 A$			150	A/μs
, ,,,		$t_{\rm P} = 200 \mu {\rm s}; di_{\rm G}/dt = 0.45 {\rm A}/\mu {\rm s};$	•				· ·
			on-repet., $I_{T} = 21 \text{ A}$			500	A/µs
(dv/dt) _{cr}	critical rate of rise of voltage	$V = \frac{2}{3} V_{\text{DBM}}$	T _{vJ} = 125°C			1000	i
	C C	$R_{GK} = \infty$; method 1 (linear volta					
V _{gT}	gate trigger voltage	$V_{\rm D} = 6 \text{ V}$	$T_{VJ} = 25^{\circ}C$			1	V
- 01			$T_{VJ} = -40 ^{\circ}\text{C}$			1.2	v
I _{GT}	gate trigger current	$V_{D} = 6 V$	$T_{y_J} = 25^{\circ}C$			65	mA
-61			$T_{\rm VJ} = -40^{\circ}\rm C$			80	mA
V _{gd}	gate non-trigger voltage	$V_{D} = \frac{2}{3} V_{DBM}$	$T_{VJ} = 125^{\circ}C$			0.2	V
v _{GD} I _{GD}	gate non-trigger current	U / VURM				5	mA
	latching current	t _p = 10 μs	T _{vJ} = 25°C			150	mA
I.	latorning our one	$I_{g} = 0.3 \text{ A}; \text{ di}_{g}/\text{dt} = 0.3 \text{ A}/\mu$				150	ШA
1	holding current	$V_{\rm D} = 6 V R_{\rm GK} = \infty$	s T _{vJ} = 25°C			100	mA
I _H			$T_{VJ} = 25 \text{ C}$ $T_{VJ} = 25 \text{ C}$				i
	gate controlled delay time	$V_{D} = \frac{1}{2} V_{DRM}$				2	μs
t _{gd}							
t _q	turn-off time	$\frac{I_{G} = 0.3 \text{ A}; \text{ di}_{G}/\text{dt} = 0.3 \text{ A}/\mu_{H}}{V_{R} = 100 \text{ V}; I_{T} = 15\text{ A}; \text{ V} = \frac{2}{3}$			150		μs

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Package TO-240AA					Ratings			
Symbol	Definition	Conditions			min.	typ.	max.	Unit
I _{RMS}	RMS current	per terminal					200	Α
T _{vj}	virtual junction temperature				-40		125	°C
T _{op}	operation temperature				-40		100	°C
T _{stg}	storage temperature				-40		125	°C
Weight						81		g
M _D	mounting torque				2.5		4	Nm
M _T	terminal torque				2.5		4	Nm
d _{Spp/App}	creepage distance on surface striking distance through air		terminal to terminal	13.0	9.7			mm
d _{Spb/Apb}	creepage distance on suna	ce striking distance through an	terminal to backside	16.0	16.0			mm
V	isolation voltage	t = 1 second	50/60 Hz. RMS: liso∟≤ 1 mA		4800			V
		t = 1 minute			4000			V



Date Code

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MCC21-16io8B	MCC21-16io8B	Box	36	477338

Similar Part	Package	Voltage class
MCMA25P1600TA	TO-240AA-1B	1600
MCMA35P1600TA	TO-240AA-1B	1600

Equiva	alent Circuits for	Simulation	* on die level	$T_{VJ} = 125^{\circ}C$
)R	Thyristor		
V _{0 max}	threshold voltage	0.85		V
$\mathbf{R}_{0 \text{ max}}$	slope resistance *	13.8		mΩ

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Outlines TO-240AA



Optional accessories for modules

Keyed gate/cathode twin plugs with wire length = 350 mm, gate = white, cathode = red Type ZY 200L (L = Left for pin pair 4/5) Type ZY 200R (R = Right for pin pair 6/7) UL 758, style 3751





Thyristor





Fig. 2 Gate trigger delay time

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